

# TEPxxD SERIES

## **DESCRIPTION**

The TEPxxD series are ultra low capacitance transient voltage suppressor arrays. The TEPxxD series provide circuit protection for high-speed data transmission interfaces in wired and wireless computing and networking applications.

The TEPxxD Series meet IEC 61000-4-2 (ESD), IEC 61000-4-4 (EFT) and IEC61000-4-5(Surge). The TEPxxD Series offer an ultra low capacitance protection solution for circuits operating at high frequencies and faster edge rates, where insertion loss and signal integrity are serious concerns.

# ORDERING INFORMATION

→ Device:TEPxxD→ Package: SOT-23→ Material: Halogen free→ Packing: Tape & Reel

♦ Quantity per reel: 3,000pcs

#### **FEATURES**

♦ Transient protection for high-speed data lines IEC 61000-4-2 (ESD) 8kV (Contact) 15kV (Air)

IEC 61000-4-4 (EFT) 40A (5/50 ns)

- ♦Protects tow I/O lines
- ♦Working voltages: 5V, 12V, 15V, 24V
- ♦Low clamping voltage
- ♦Low leakage current
- ♦ Response time is < 1 ns

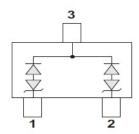
# **MACHANICAL DATA**

- ♦SOT-23 package
- ♦Flammability Rating: UL 94V-0
- ♦ Packaging: Tape and Reel
- ♦High temperature soldering guaranteed: 260°C/10s
- ♦Reel size: 7 inch
- ♦MSL1

## **APPLICATIONS**

- ♦ High-Speed Data Transmission Interfaces
- ♦ Cellular Phones
- ♦Portable Electronics
- ♦Wireless Bus Protection

#### PIN CONFIGURATION



## **PACKAGE OUTLINE**



# **ABSOLUTE MAXIMUM RATING**

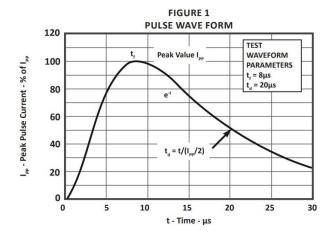
Symbol	Parameter	Value	Units
V <sub>ESD</sub>	ESD per IEC 61000-4-2 (Contact) ESD per IEC 61000-4-2 (Air)	8 15	kV
P <sub>PP</sub>	Peak Pulse Power (8/20µs)	350	W
Торт	Operating Temperature	-55/+150	°C
T <sub>STG</sub>	Storage Temperature	-55/+150	°C
TL	Lead Soldering Temperature	260	°C

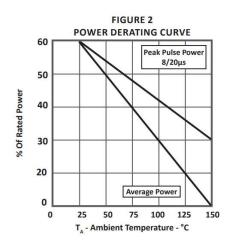
		$V_{RWM}$	V <sub>B</sub> @1mA	V <sub>C</sub> @Ipp		V <sub>C</sub> @Ipp		$I_R$	Ст
PART	DEVICE	(V)	(V)	(\	<b>/</b> )	(\	/)	(µA)	(pF)
NUMBER	JMBER MARKING	Max	Min	Max	lpp (A)	Max	lpp (A)	Max	Max.
TEP05D	T2S	5.0	6.0	9.8	1	11	5	1	0.8
TEP12D	DJ2	12.0	13.3	19	1	24	5	1	0.8
TEP15D	DJ5	15.0	16.7	24	1	30	5	1	0.8
TEP24D	DJ4	24.0	26.7	43	1	55	5	1	0.8

Note: above parameters are Pin 1 or Pin 2 to Pin3.

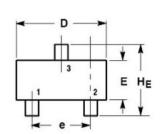


# RATING AND CHARACTERISTICS CURVES (TEPxxD SERIES)

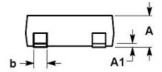


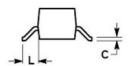


# **SOT-23 PACKAGE OUTLINE DIMENSIONS**



	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.89	1.00	1.11	0.035	0.040	0.044	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
b	0.37	0.44	0.50	0.015	0.018	0.020	
С	0.09	0.13	0.18	0.003	0.005	0.007	
D	2.80	2.90	3.04	0.110	0.114	0.120	
E	1.20	1.30	1.40	0.047	0.051	0.055	
е	1.78	1.90	2.04	0.070	0.075	0.081	
L	0.35	0.54	0.69	0.014	0.021	0.029	
HE	2.10	2.40	2.64	0.083	0.094	0.104	







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